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MDT0200FIH-MULTI	240 x 320	MULTI Interface	TFT Module						
Specification									
Version: 1		Date: 18/07/2022							
		Revision							
1 16	6/07/2022	First issue							

Display F			
Display Size	2.00"		
Resolution	240 x 320		
Orientation	Portrait		
Appearance	RGB		\
Logic Voltage	3.3V		
Interface	MCU / SPI		ОПЭ
Brightness	950 cd/m ²		mnliant
Touchscreen	SPLA	X Su	mphant
Module Size	38.80 x 52.30 x 2.15mm		
Operating Temperature	-20°C ~ +70°C		
Pinout	40 way FFC	Box Quantity	Weight / Display
Pitch	0.5mm		

DESIGN • MANUFACTURE • SUPPLY * - For full design functionality, please use this specification in conjunction with the ST7789VI specification.(Provided Separately)

Display Accessories					
Part Number	Description				
MPBV6	40 Way FFC to cable and wires. Driven by any driver board that can be wired to a 1mm pitch SHDR-40V-S-B receptacle.				

Optional Variants						
Appearances	Voltage					

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Summary

TFT 2.0" is a IPS transmissive type color active matrix TFT liquid crystal display that use amorphous silicon TFT as switching devices. This module is a composed of a TFT_LCD module, It is usually designed for industrial application and this module follows RoHs.

General Specifications

- Size: 2.0" inch
- Dot Matrix: 240 x RGB x 320(TFT) dots
- Module dimension: 38.8(W) x 52.3(H) x 2.15(D) mm
- Active area: 30.60 x 40.80 mm
- Pixel Pitch: 0.1275 x 0.1275 mm
- LCD type: TFT, Normally Black, Transmissive
- TFT Interface: MCU / SPI
- TFT Driver IC: ST7789VI or Equivalent
- Viewing angle: 80/80/80/80
- Aspect Ratio: 3 : 4 DESIGN • MANUFACTURE • SUPPLY
- Backlight Type: LED,Normally White
- With /Without TP: Without TP
- Surface: Glare

*Color tone slight changed by temperature and driving voltage.

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Interface

1. LCM PIN Definition

NO	Symbol	Function							
1	GND	Grou	Ground						
2	NC	No co	No connection						
3	NC	No co	onnect	ion					
4	NC	No co	onnect	ion					
5	NC	No co	onnect	ion					
6	NC	No co	onnect	ion					
7	VDD	Powe	er supp	oly					
8	VDDI	Powe	er Sup	oly for	I/O System.				
9	TE	Teari writin If not	ng effe g. <u>used,</u>	ect sig pleas	nal is used to synch e let this pin open	ronize MCU	to frame memory		
10	CSX	Chip Low e High	select enable disabl	ion pir e.					
11	DCX(SCL)	(D/C) interfa DCX= DCX= (SCL)	(D/CX): This pin is used to select "Data or Command" in the parallel interface. DCX='1': display data or parameter. DCX='0': command data.						
12	WRX(D/CX)	Displa Seco (WR> (D/C> If not	ay dat nd Da (): Wri (): Wh used.	a/com ta lane te ena en 4-s pleas	mand selection e in 2 data lane seria able in MCU parallel SPI mode,This pin in e fix this pin at VDDI	I interface. interface. 4-line serial or GND.	interface		
13	RDX	-Read	d enat	ole in 8	3080 MCU parallel in	iterface.			
14~29	DB0~DB15	Data	bus lir	, <u>piou</u> 1e					
30	RESX	Syste signa	m res l is ac	et pin. tive lo	W				
31	IMO	The N	/ICU ir	nterfac	ce mode select.				
32	IM1	IM2	IM1	IM0	MPU Interface Mode	Data pin			
		0	0	0	80-8bit parallel I/F	DB[7:0]			
		0	0	1	80-16bit parallel I/F	DB[15:0]			
		0	1	0	80-9bit parallel I/F	DB[8:0]			
33	IM2	0	1	1	80-18bit parallel I/F	DB[17:0],			
		1	0	1	3-line 9bit serial I/F	SDA: in/out			
		1	1	0	4-line 8bit serial I/F	SDA: in/out			
34~35	DB16~DB17	Data	Data bus line						
36	VLED-	Catho	Cathode of LED backlight.						

37	VLED-	Cathode of LED backlight.
38	VLED+	Anode of LED backlight.
39	NC(SDA)	When SPI mode, This pin is SPI interface input/output pin. The data is latched on the rising edge of the SCL signal. If not used(NC), please fix this pin at VDDI or GND level.
40	NC	No connection

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Contour Drawing





Absolute Maximum Ratings

ltem	Symbol	Min	Тур	Max	Unit
Operating Temperature	TOP	-20	—	+70	°C
Storage Temperature	TST	-30	—	+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

Electrical Characteristics

1. Operating conditions

ltem	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Analog	Vdd	_	2.4	3.3	3.6	V
Interface Operation Voltage	Vddi	_	1.65	1.8	3.6	V
Supply Current For LCM	lod	$V_{DD} = V_{DDI}$ = Vcc=3.0V	_	6.0	9.0	mA

Note: to avoid power supply noise, please avoid using driving conditions close to min, or max value

2. LED driving conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit	Remark
LED current SIGN	MAN	JFAC	TORE	•-s	J mA	Y -
LED voltage	VLED+	5.5	6.0	6.5	V	Note 1
LED Life Time	_	_	50,000	_	Hr	Note 2,3,4

Note 1 : There are 1 Groups LED



Back Light Circuit

Note 2 : Ta = 25 °C

Note 3 : Brightness to be decreased to 50% of the initial value

Note 4 : The single LED lamp case

Temp. ≦60°C, 90% RH MAX. Temp. >60°C, Absolute humidity shall be less than 90% RH at 60°C

DC Characteristics

Parameter	Symbol		Rating	Unit	Condition	
i arameter	Cymbol	Min	Тур	Max	Unit	Condition
Low level input voltage	VIL	0	-	0.3VCC	V	
High level input voltage	Vін	0.7VCC	-	VCC	V	

AC Characteristics

1. 8080 Series MCU Parallel Interface Characteristics: 18/16/9/8-bit Bus



Figure 1Parallel Interface Timing Characteristics (8080-Series MCU Interface)

Signal	Symbol	Parameter	Min	Max	Unit	Description
	TAST	Address setup time	0		ns	
D/CX	ТАНТ	Address hold time (Write/Read)	10		ns	-
CSX	TCHW	Chip select "H" pulse width	0		ns	_
00/	TCS	Chip select setup time (Write)	15		ns	
	TRCS	Chip select setup time (Read ID)	45		ns	
	TRCSFM	Chip select setup time (Read FM)	355		ns	
	TCSF	Chip select wait time (Write/Read)	10		ns	
	TCSH	Chip select hold time	10		ns	
WRX	TWC	Write cycle	66		ns	
, , , , , , , , , , , , , , , , , , ,	TWRH	Control pulse "H" duration	15		ns	
	TWRL	Control pulse "L" duration	15		ns	
RDX (ID)	TRC	Read cycle (ID)	160		ns	When read ID data
,	TRDH	Control pulse "H" duration (ID)	90		ns	
	TRDL	Control pulse "L" duration (ID)	45		ns	
עחפ	TRCFM	Read cycle (FM)	450	_	ns	When road from
	TRDHFM	Control pulse "H" duration (FM)	90	Y	ns	
(FIVI)	TRDLFM	Control pulse "L" duration (FM)	355		ns	frame memory
D[17:0]	TDST	Data setup time	10		ns	For CL=30pF
De	5 SHGN	Data hold time ACTU	10	• •	5 ins F	PLY
	T _{RAT}	Read access time (ID)		40	ns	
	TRATEM	Read access time (FM)		340	ns	
	T _{ODH}	Output disable time	20	80	ns	

VDDI=1.65 to 3.6V, VDD=2.4 to 3.6V, GND=0V, Ta= 25 $\,^\circ\!\mathrm{C}$

 Table 8080 Parallel Interface Characteristics



Figure 2 Rising and Falling Timing for I/O Signal



Figure 3 Write-to-Read and Read-to-Write Timing

Note: The rising time and falling time (Tr, Tf) of input signal and fall time are specified at 15 ns or less. Logic high and low levels are specifiedas 30% and 70% of VDDI for Input signals.



2. 3-line Serial Interface



Figure 4 3-line serial Interface Timing Characteristics

Signal	Symbol	Parameter	Min	Max	Unit	Description
	Tcss	Chip select setup time (write)	15		ns	
	Тсян	Chip select hold time (write)	15		ns	
CSX	Tcss	Chip select setup time (read)	60		ns	
	Tscc	Chip select hold time (read)	65		ns	
	Тснw	Chip select "H" pulse width	40		ns	
	Tscycw	Serial clock cycle (Write)	16	HF 프리	ns	
	Тзни	SCL "H" pulse width (Write)	7		ns	
0.01	Tslw	SCL "L" pulse width (Write)	7		ns	
SCL	TSCYCR	Serial clock cycle (Read)	150	i	ns	
	TSHR	SCL "H" pulse width (Read)	60		ns	
	TSLR	SCL "L" pulse width (Read)	60	· · · · · · · · · · · · · · · · · · ·	ns	
SDA	Tsps	Data setup time	7	1.1.1.1	ns	· · · · · · · · · · · · · · · · · · ·
(DIN)	Тзрн	Data hold time	7		ns	
SDA	TACC	Access time	10	50	ns	For maximum CL=30pF
(DOUT)	Тон	Output disable time	15	50	ns	For minimum CL=8pF

VDDI=1.65 to 3.6V, VDD=2.4 to 3.6V, GND=0V, Ta= 25 $\,^\circ\!\mathrm{C}$

Table 3-line serial Interface Characteristics

3. Reset Timing:



Figure 5 Reset Timing

VDDI=1.65 to 3.6V, VDD=2.4 to 3.6V, GND=0V, Ta=25 °C

Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10 -		us
	TOT	Development	8	5 (Note 1, 5)	ms
	IRI	Reset cancel	-	120 (Note 1, 6, 7)	ms

Notes:

1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.

2. Spike due to an electrostatic discharge on RESXline does not cause irregular system reset according to the table below:

RESX Pulse	Action	
Shorter than 5us	Reset Rejected	
Longer than 9us	Reset	JPPLY
Between 5us and 9us	Reset starts	

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.

4. Spike Rejection also applies during a valid reset pulse as shown below:



- 5. When Reset applied during Sleep In Mode.
- 6. When Reset applied during Sleep Out Mode.

7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

4. Power sequences





Optical Characteristics

Item		Symbol	Condition.	Min	Тур.	Max.	Unit	Remark
Response time		Tr+ Tf	θ=0°、Φ=0°	-	35	45	ms	Note 3
Contrast ratio		CR	At optimized viewing angle	640	800	-	-	Note 4
Color	\//bito	Wx	θ=0°、Φ=0	0.246	0.296	0.346		Note 2,6,7
Chromaticity	vvnite	Wy		0.275	0.325	0.375		
	Hor	ΘR	CR≧10	-	80	-	Deg.	Note 1
(Gray Scale		θL		-	80	-		
Inversion	Ver.	ΦΤ		-	80	-		
Direction)		ΦВ		-	80	-		
Brightness		-	-	850	950	-	cd/m ²	Center of display
Uniformity		(U)	-	75	-	-	%	Note5

Ta=25±2℃

Note 1: Definition of viewing angle range



Fig. 11.1. Definition of viewing angle

Note 2: Test equipment setup: ANUFACTURE SUPPL After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7 or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.



Fig. 11.2. Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, Tr, is the time between photo detector output intensity changed from 90% to 10%. And fall time, Tf, is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

Contrast ratio (CR) = $\frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$

Note 5: Definition of Luminance Uniformity Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area. Luminance Uniformity (U) = Lmin/Lmax x100% L = Active area lengthW = Active area width X(V/A)X/3 _X/3 Q > 1 3 JRE SUPPLY ICACTI M > 7 (6) (5) (4) Ś M (9) (7)(8)

Fig 11.3. Definition of uniformity

Note 6: Definition of color chromaticity (CIE 1931) Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

Reliability

Environmental Test						
Test Item	Content of Test	Test Condition	Note			
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2			
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2			
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs				
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1			
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max	60°C,90%RH 96hrs	1,2			
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles				
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3			
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Contact±4KV Air±8KV 10 times	4			

Content of Reliability Test (Wide temperature, -20°C~70°C)

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

Note4: Some performance degradation allowed. Need Power off self-recoverable.No hardware failure

Initial Code For Reference

{

void ST7789SV_RF0200B(void) for SPI & MCU mode Write_Command(0x11); //Sleep out delay(150); //Delay 120ms Write_Command(0x36); // Write_Data(0x00); Write_Command(0x3A); // Write_Data(0x55); //ST7789S Frame rate setting Write_Command(0xb2); //Porch Setting Write_Data(0x0c); Write_Data(0x0c); Write_Data(0x00); Write_Data(0x33); Write_Data(0x33); Write_Command(0xb7); //Gate Control //Write_Data(0x35); //vgh vgl Write_Data(0x64); //ST7789S Power setting SUPPLY Write_Command(0xbb); //Gate Control VCOMS=1.425V Write_Data(0x30); Write_Command(0xc0); //LCM Control Write_Data(0x2c); Write Command(0xc2); //VDV and VRH Command Enable Write_Data(0x01); Write_Command(0xc3); //VRH Set (AVDD=VRH+1.675 Write_Data(0x0b); Write_Command(0xc4); //VRH Set Write Data(0x20); Write_Command(0xc6); //Frame Rate Control in Normal Mode Write_Data(0x0f); Write Command(0xca); //Register Value Selection 2 Write_Data(0x0f); Write_Command(0xc8); //Register Value Selection 1 Write Data(0x08); Write_Command(0x55); //Write Content Adaptive Brightness Control and Color Enhancemen

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Write_Data(0x90); Write_Command(0xd0); //Power Control Write_Data(0xa4); Write_Data(0xa1); Write_Command(0x35); //

Write_Command(0x26); //Set Gamma Write_Data(0x02);

//ST7789S gamma setting Write_Command(0xe0); Write_Data(0xd0); Write_Data(0x00); Write_Data(0x02); Write_Data(0x07); Write_Data(0x0b); Write_Data(0x1a); Write_Data(0x31); Write_Data(0x54); Write_Data(0x40); Write_Data(0x29); Write_Data(0x12); Write_Data(0x12); Write_Data(0x12); Write_Data(0x17); Write_Command(0xe1); Write_Data(0xd0); Write_Data(0x00); Write Data(0x02); Write_Data(0x07); Write_Data(0x05); Write_Data(0x25); Write_Data(0x2d); Write_Data(0x44); Write_Data(0x45); Write_Data(0x1c); Write_Data(0x18); Write_Data(0x16); Write_Data(0x1c); Write_Data(0x1d);

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t

Write_Command(0x21);

Write_Command(0x2A); Write_Data(0x00); Write_Data(0x00); Write_Data(0x00); Write_Data(0xEF);

> Write_Command(0x2B); Write_Data(0x00); Write_Data(0x0); Write_Data(0x01); Write_Data(0x3F);

Write_Command(0x29);

}

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